



Product Change Notification

Change Notification #: 116439 - 00
Change Title: Intel® Server Chassis P4000XXSFDR
PCN 116439-00, Label, Update regulatory label BIS safety mark and update BSMI logo with RoHS text on the label
Date of Publication: August 29, 2018

Key Characteristics of the Change:

Label Update

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	September 13, 2018
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*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Chassis P4000XXSFDR.

1. Update BIS mark regulatory label implementation for PSU.
2. Update the packaging regulatory label, by replacing the BSMI logo with the new version that includes RoHS text to the label.

Please see Figure-1 and Figure-2 below for details.

Figure-1 Old label

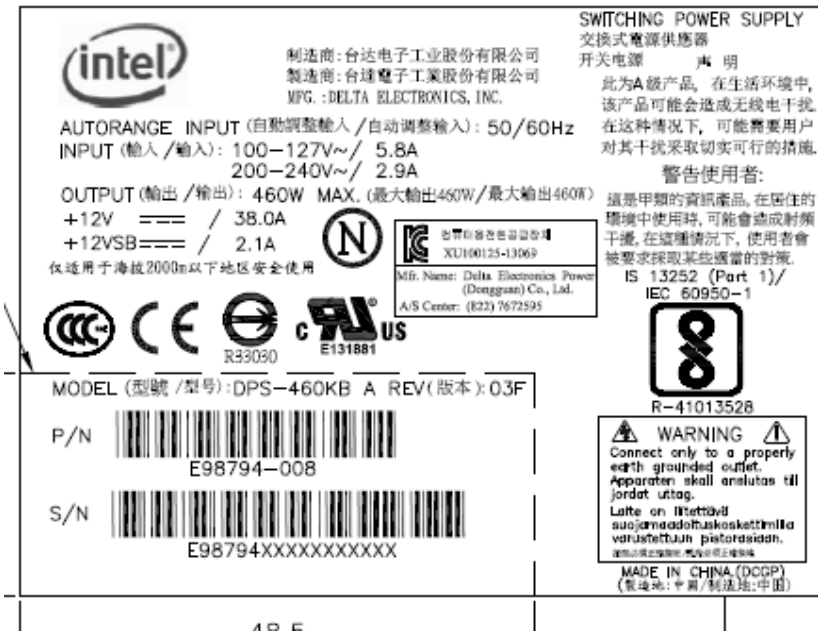
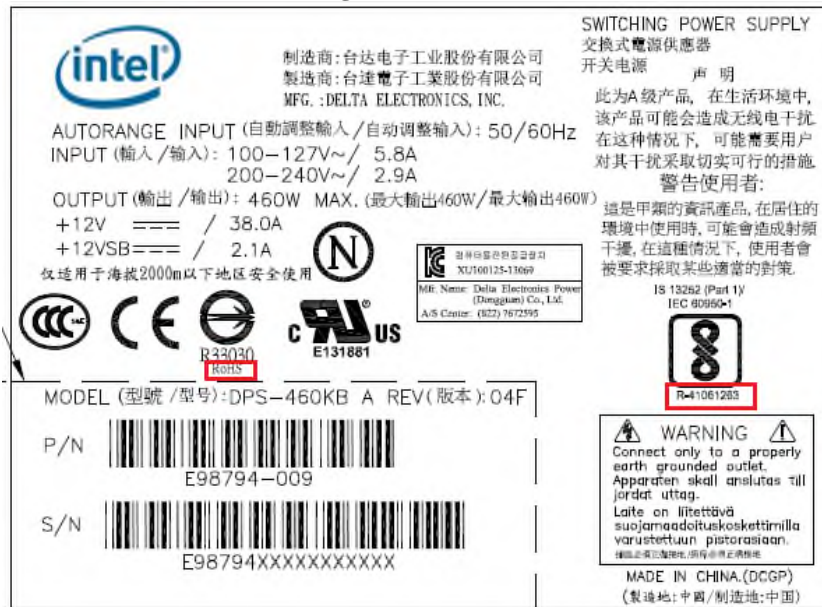


Figure-2 New label



Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand these changes and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
P4000XXSFDR	944468	J12838-001	H87822-206	J12838-002	H87822-206

PCN Revision History:

Date of Revision: August 29, 2018	Revision Number: 00	Reason: Originally Published PCN
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Product Change Notification

116439 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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